

AMENDMENTS TO THE SPECIFICATION

The following is a complete, marked up listing of the amended paragraphs of the Specification with underlined text indicating insertions, and strikethrough and/or double-bracketed text indicating deletions.

Please amend paragraphs [0004] and [0050] as indicated below:

[0004] The structure of a conventional film carrier tape will be described with reference to FIGS. 1–3. FIG. 1 is a perspective view of a conventional film carrier tape (10) comprising a base film (100), a wiring pattern (154) formed on the upper side of the base film (100) and a reinforcement metal pattern (152). The base film (100) comprises a main area (110) through which a chip installation hole 112 is formed and on which the wiring pattern (154) is formed, and a peripheral area (120) on which a plurality of sprocket holes (122) is formed.

[0050] FIGS. 11(a) and 11(b) show the deformation of sprocket holes caused by the sprocket. FIG. 11(a) shows the shapes of sprocket hole before and after the deformation. In order to describe the deformation pattern of the sprocket holes, the deformation was measured at 8 ~~[[equi-spaced]]~~ equi-spaced positions along the X-direction in FIG. 11(a). FIG. 11(b) shows the deformation of the sprocket holes at the above-described 8 equi-spaced positions. As shown in FIG. 11(b), the deformation of the

sprocket hole according to the present invention is much smaller than that according to the conventional art using the reinforcement metal pattern made of Cu.

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